

# MOS FIELD EFFECT TRANSISTOR 2SK3365

# SWITCHING N-CHANNEL POWER MOS FET

#### **DESCRIPTION**

The 2SK3365 is N-Channel MOS Field Effect Transistor designed for DC/DC converters application of notebook computers.

#### **FEATURES**

• Low on-resistance

 $R_{DS(on)1}$  = 14  $m\Omega$  (MAX.) (V<sub>GS</sub> = 10 V, I<sub>D</sub> = 15 A)

 $R_{DS(on)2} = 21 \text{ m}\Omega \text{ (MAX.) (VGS} = 4.5 \text{ V, ID} = 15 \text{ A)}$ 

 $R_{DS(on)3} = 29 \text{ m}\Omega \text{ (MAX.) (VGS} = 4.0 \text{ V, ID} = 15 \text{ A)}$ 

- Low Ciss : Ciss = 1300 pF (TYP.)
- · Built-in gate protection diode

#### **★ ORDERING INFORMATION**

PART NUMBER	PACKAGE		
2SK3365	TO-251 (MP-3)		
2SK3365-Z	TO-252 (MP-3Z)		

#### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage (V <sub>GS</sub> = 0 V)	VDSS	30	V
Gate to Source Voltage (V <sub>DS</sub> = 0 V)	Vgss	±20	V
Drain Current (DC)	I <sub>D(DC)</sub>	±30	Α
Drain Current (Pulse) Note	D(pulse)	±120	Α
Total Power Dissipation (Tc = 25 °C)	PT	36	W
Total Power Dissipation (T <sub>A</sub> = 25 °C)	PT	1.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	T <sub>stg</sub>	-55 to + 150	°C

**Note** PW  $\leq$  10  $\mu$ s, Duty cycle  $\leq$  1%

#### THERMAL RESISTANCE

Channel to case Thermal Resistance	Rth(ch-C)	3.48	°C/W
Channel to ambient Thermal Resistance	Rth(ch-A)	125	°C/W

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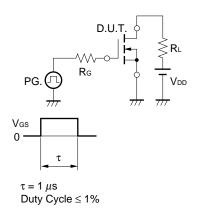


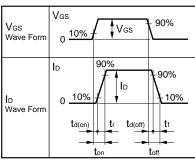
### **ELECTRICAL CHARACTERISTICS (TA = 25 °C)**

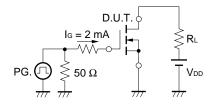
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A		11.5	14	mΩ
	RDS(on)2	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 15 A		15.2	21	mΩ
	RDS(on)3	V <sub>GS</sub> = 4.0 V, I <sub>D</sub> = 15 A		18	29	mΩ
Gate to Source Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.5	2.0	2.5	٧
Forward Transfer Admittance	y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 15 A	8.0	16.0		S
Drain Leakage Current	IDSS	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V			10	μΑ
Gate to Source Leakage Current	Igss	V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0 V			±10	μΑ
Input Capacitance	Ciss	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1300		pF
Output Capacitance	Coss			405		pF
Reverse Transfer Capacitance	Crss			190		pF
Turn-on Delay Time	<b>t</b> d(on)	I <sub>D</sub> = 15 A, V <sub>GS</sub> = 10 V, V <sub>DD</sub> = 15 V,		37		ns
Rise Time	<b>t</b> r	$R_G = 10 \Omega$		500		ns
Turn-off Delay Time	t <sub>d(off)</sub>			75		ns
Fall Time	tf			95		ns
Total Gate Charge	QG	I <sub>D</sub> = 30 A, V <sub>DD</sub> = 24 V, V <sub>GS</sub> = 10 V		25		nC
Gate to Source Charge	Qgs			4.5		nC
Gate to Drain Charge	Q <sub>GD</sub>			7.0		nC
Body Diode forward Voltage	V <sub>F(S-D)</sub>	IF = 30 A, V <sub>GS</sub> = 0 V		1.0		V
Reverse Recovery Time	trr	I <sub>F</sub> = 30 A, V <sub>GS</sub> = 0 V		35		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		32		nC

#### **TEST CIRCUIT 1 SWITCHING TIME**

# TEST CIRCUIT 2 GATE CHARGE

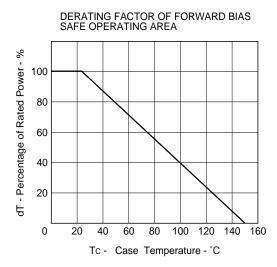




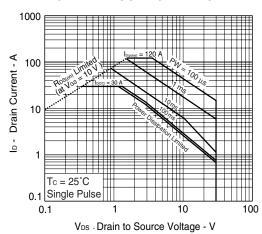




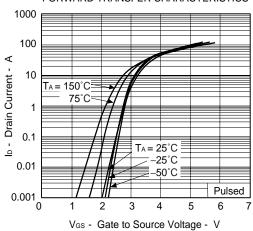
#### TYPICAL CHARACTERISTICS (TA = 25°C)

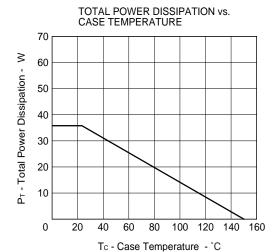


#### FORWARD BIAS SAFE OPERATING AREA

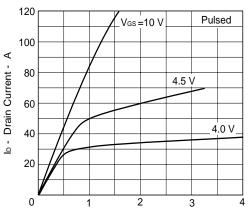


FORWARD TRANSFER CHARACTERISTICS



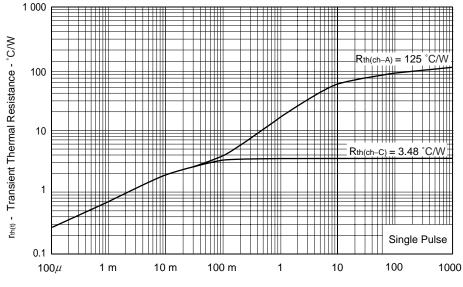


DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



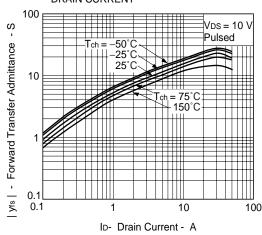
V<sub>DS</sub> - Drain to Source Voltage - V

#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

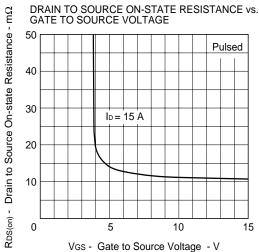


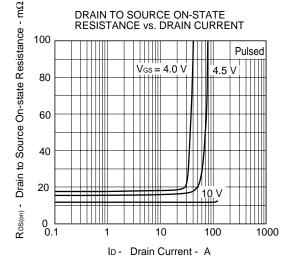
PW - Pulse Width - s

#### FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

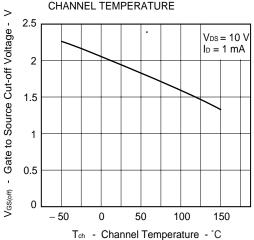


## Pulsed

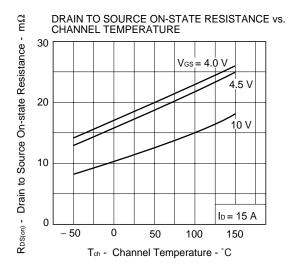


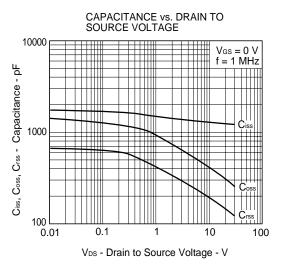


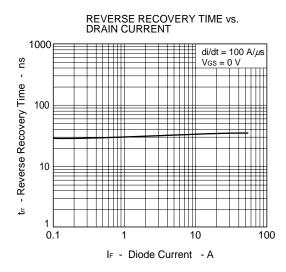
#### GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE

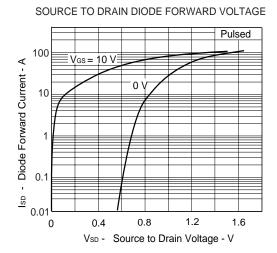


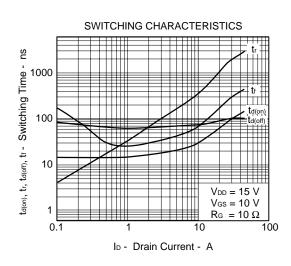


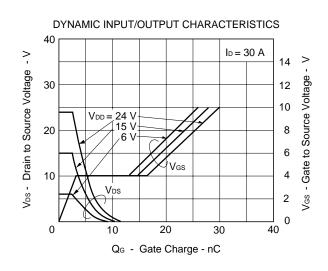








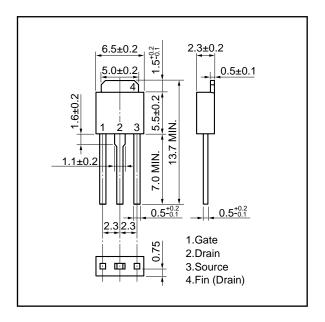




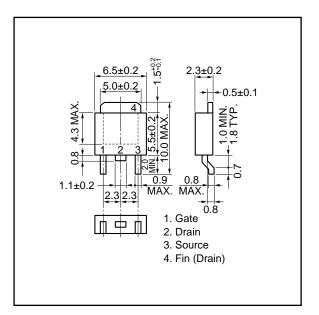


#### **PACKAGE DRAWINGS (Unit: mm)**

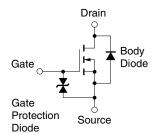
#### **★** 1) TO-251 (MP-3)



#### 2) TO-252 (MP-3Z)



#### **EQUIVALENT CIRCUIT**



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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